Bluetooth Module Datasheet

Model: SJR-BTM308-C

Version: V1.1

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1 Introduction

Sky Jiarun Technologies introduces the pioneer of the Bluetooth 5.0 modules SJR-BTM308-C which is a high performance, cost effective, low power and compact solution. The Bluetooth module provides a complete 2.4GHz Bluetooth system based on the QCC3008 QFN chipset which is a single chip radio and baseband IC for Bluetooth 2.4GHz systems,. This module is fully qualified single-chip dual mode Bluetooth@v5.0 system.

2 Key Features

Bluetooth Profiles

- Bluetooth v5.0 specification support
- Qualcomm® Bluetooth® Low Energy secure connection
- A2DP v1.3.1
- AVRCP v1.6
- HFP v1.7
- HSP v1.2
- SPP v1.2
- DID v1.3
- HOGP v1.0
- PXP v1.0.1
- FMP v1.0
- BAS v1.0
- QTIL's proximity pairing and QTIL's proximity connection

Music Enhancements

- aptX, aptX Low Latency, SBC, and AAC audio codecs
- Qualcomm TrueWireless[™] Stereo (TWS), which allows two devices to be configured as a stereo pair
- Configurable Signal Detection to trigger events
- 1 bank of up to 10-stage Speaker Parametric EQ
- 6 banks of up to 5-stage User Parametric EQ for music enhancement
- Qualcomm® meloD™ Expansion audio processing: 3D stereo widening
- Compander to compress or expand the dynamic range of the audio
- Post Mastering to improve DAC fidelity
- Dual I² S outputs with crossover

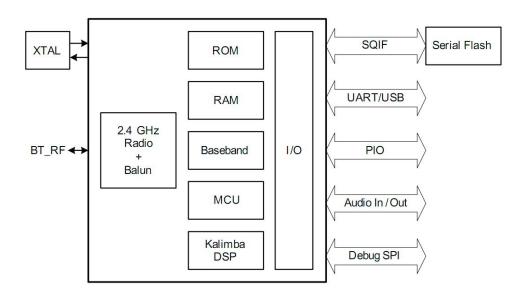
Additional Functionality

- Support for multi-language programmable audio prompts
- Multipoint support for A2DP connection to 2 A2DP sources for music playback
- Talk-time extension, which automatically reduces processor functions to extend use when a low battery condition is detected
- Slim module with 13.5mm x 21mm x 2.0mm

3 Applications

- Stereo Headsets
- Wired Stereo headsets and headphones
- Portable Bluetooth Stereo speakers

4 Block Diagram

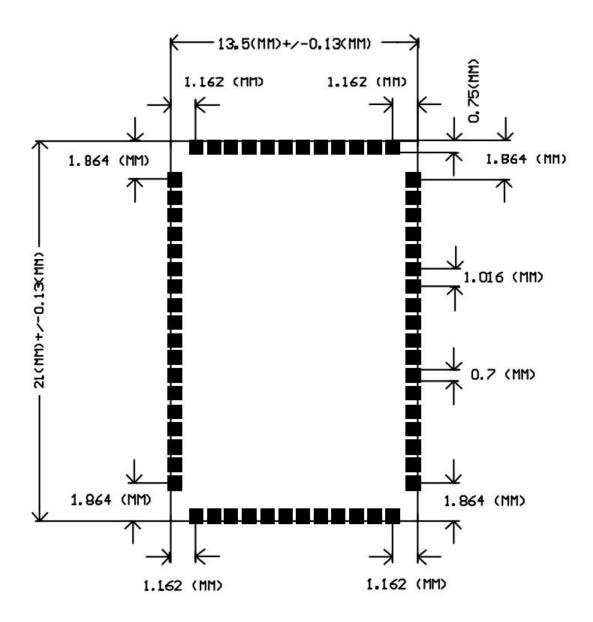


5 General specifications

Model Name	SJR-BTM308-C	
Product Description	Bluetooth 5.0 Class2 Module	
Bluetooth Standard	Bluetooth 5.0	
Chipset	QCC3008 QFN	
Dimension	13.5mm x 21mm x 2.0mm	
Operating Conditions		
Voltage	2.8~4.2V	
Temperature	-10∼+70℃	
Storage Temperature	-40∼+85℃	
Electrical Specifications		
Frequency Range	2402~2480MHz	
Maximum RF Transmit Power	9dBm	
л /4 DQPSK Receive Sensitivity	-92dBm	
8DPSK Receive Sensitivity	-82dBm	

6 Module Package Information

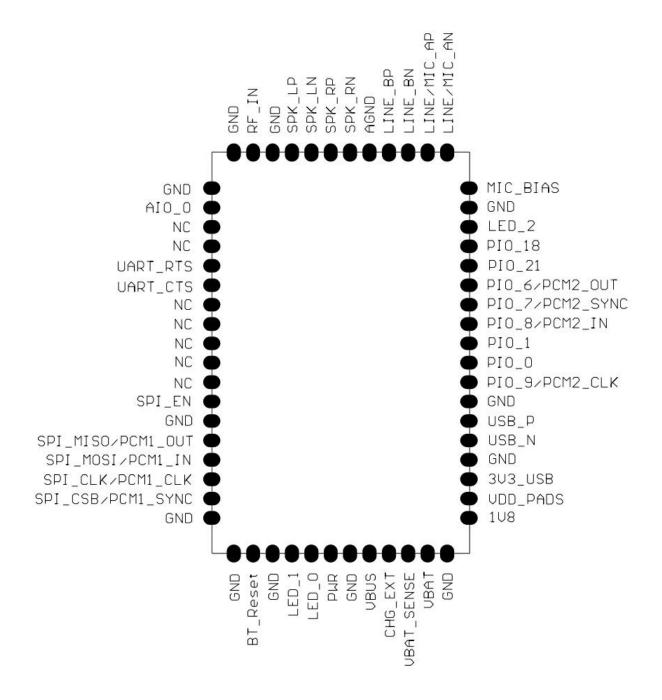
6.1 Pinout Diagram and package dimensions



Unit: MM

Recommended PCB layout footprint

6.2 Module Pin descriptions



Pin#	Pin Name	Pin Type	Description
1	GND	Ground	Ground
2	AIO_0	Analogue input/output	Analogue programmable input/ output line 0.
3	NC	NC	NC
4	NC	NC	NC
5	UART_RTS/PIO_16	Bidirectional with strong pull-up	UART request to send, active low Alternative function: ■ PIO_16 Programmable input/output line 16.

			UART clear to send active low
6	UART_CTS/PIO_17	Bidirectional with strong pull-down	Alternative function:
			■ PIO_17 Programmable input/output line 17.
7	NC	NC	NC
8	NC	NC	NC
9	NC	NC	NC
10	NC	NC	NC
11	NC	NC	NC
12	SPI_PCM	Input with weak pull-down	SPI/I2S# select input ■ 0=I2S/PIO interface ■ 1=SPI
13	GND	Ground	Ground
14	SPI_MISO	Bidirectional with weak pull-down	SPI data output Alternative function: PIO_3: Programmable input/output line 3. I2S1_SD_OUT: I2S1 synchronous data output
15	SPI_MOSI	Bidirectional with weak pull-down	SPI data input Alternative function: PIO_2: Programmable input/output line SPDIF_IN: SPDIF input I2S1_SD_IN:I2S1 synchronous data input
16	SPI_CLK	Bidirectional with weak pull-down	SPI clock Alternative function: PIO_5: Programmable input/output line I2S1_CLK: I2S1 synchronous data clock
17	SPI_CSB	Bidirectional with weak pull-down	Chip select for SPI,active low Alternative function: ■ PIO_4: Programmable input/output line 4. ■ I2S1_WS: I2S1 word select
18	GND	Ground	Ground
19	GND	Ground	Ground
20	BT_Reset	Input with strong pull-up	Reset if low. Pull low for minimum 5 ms to cause a reset
21	GND	Ground	Ground
22	LED_1	Bidirectional	Open-drain output
23	LED_0	Bidirectional	Open-drain output
24	PWR	CMOS Input	Regulator enable and multifunction button. A high input (tolerant to VBAT voltages) enables the on-chip regulators, which can then be latched on internally and the button used as a multifunction input.
25	GND	Ground	Ground
26	VBUS	Charge input	Charge input. Typically connected charger
27	CHG_EXT	Exernal battery charger control	External battery charger transistor base control when using external charger boost. Otherwise leave unconnected.
28	VBAT_SENSE	CMOS Input	Battery charger sense input.
29	VBAT	Power Input	Positive supply for BT Module,or battery positive terminal

30	GND	Ground	Ground	
31	1V8	Power output	Auxiliary regulator output (1.8V out)	
32	VDD PADS	Power output	3.3V Positive supply output	
33	3V3 USB	Power output	3.3V bypass linear regulator output	
34	GND	Ground	Ground	
35	USB_N	Bi-directional	USB data minus	
36	USB_P	Bi-directional	USB data plus with selectable internal 1.5kΩ pull-up resistor	
37	GND	Ground	Ground	
38	PIO_9	Bidirectional with strong pull-down	Programmable input/output line 9. Alternative function: UART_CTS: UART clear to send, active low 12S2_SD_IN: I²S2 synchronous data input	
39	PIO_0	Bidirectional with strong pull-up	Programmable input/output line 0. Alternative function: UART_RX: UART data input	
40	PIO_1	Bidirectional with strong pull-up	Programmable input/output line 1. Alternative function: UART_TX: UART data output	
41	PIO_8	Bidirectional with strong pull-up	Programmable input/output line 8. Alternative function: ■ UART_RTS: UART request to send, active low ■ I2S2_SD_IN: I²S2 synchronous data input	
42	PIO_7	Bidirectional with strong pull-down	Programmable input/output line 7. ■ I2S2_WS: I2S2 word select	
43	PIO_6	Bidirectional with strong pull-down	Programmable input/output line 6. ■ I2S2_SD_OUT: I2S2 synchronous data output	
44	PIO_21	Bidirectional with weak pull-down	Programmable input/output line 21.	
45	PIO_18	Bidirectional with weak pull-down	Programmable input/output line 18.	
46	LED_2	Bidirectional	Open-drain output	
47	GND	Ground	Ground	
48	MIC_BIAS	Analogue	Microphone bias	
49	LINE/MIC_AN	Analogue in	Microphone input negative, channel A	
50	LINE/MIC_AP	Analogue in	Microphone input positive, channel A	
51	LINE_BN	Analogue in	Line-in negative, channel B	
52	LINE_BP	Analogue in	Line-in positive, channel B	
53	GND	Ground	Ground	
54	SPK_RN	Analogue OUT	Speaker output negative, right	
55	SPK_RP	Analogue OUT	Speaker output positive, right	
56	SPK_LN	Analogue OUT	Speaker output negative, left	
57	SPK_LP	Analogue OUT	Speaker output positive, left	
58	GND	Ground	Ground	
59	RF_IN	RF	Bluetooth 50Ω transmitter output/receive input	
60	GND	Ground	Ground	

7 Electrical Characteristics

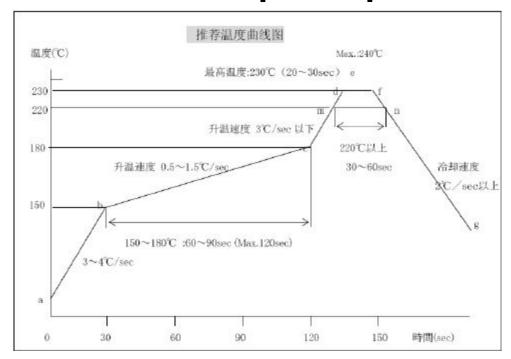
7.1 Absolute Maximum Ratings

Rating	Minimum	Maximum
Storage temperature	-40 ℃	+85℃

7.2 Recommended Operating Conditions

Operating Condition	Minimum	Maximum
Operating temperature range	-10°C	+70°C
Supply voltage: VBAT	+2.8V	+4.2V

8 Recommended reflow temperature profile





The module Must go through 125 $^{\circ}$ C baking for at least 9 hours before SMT AND IR reflow process!

若拆封后未立即上线, 天嘉润科技建议让下次上线前务必以 125℃烘烤 9 小时以上!

Record of Changes

Data	Revision	Description
2018-01-30	V1.0	Original publication of this document.
2018-07-05	V1.1	Fix PIN definition.

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